



Corres. and Mail
BOX AF

62
AK
\$

XA-9613
PATENT APPLICATION

Response Under 37 C.F.R. § 1.116
Expedited Procedure
Examining Group 3729

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Toshihiko TANAKA et al.

Appln. No.: 10/045,036

Group Art Unit: 3729

Filed: January 15, 2002

Examiner: T. PHAN

For: Wiring Substrate Manufacturing Method

AMENDMENT AFTER FINAL OFFICE ACTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Mail Stop: AF

RECEIVED

JUL 23 2004

TECHNOLOGY CENTER HJ700

Sir:

In response to the Office Action mailed on March 18, 2004, please amend the above-identified patent application as indicated below.

Amendments to the Claims, reflected in the Listing of Claims, begin on page 2 of this paper.

Remarks begin on page 5 of this paper.